

Appl. No. 10/695,187
Amtd. Dated March 20, 2006
Reply to Office Action of January 18, 2006

Docket No. IS01207AP
Customer No. 22917

UNITED STATES PATENT AND TRADEMARK OFFICE

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APPLICANT(S) Weigler, et al. GROUP ART UNIT: 1725
APPLN. NO.: 10/695,187 EXAMINER: Jonathan J. Johnson
FILED: 10/28/2003 Confirmation No. 4286
TITLE: VERTICAL REMOVAL OF EXCESS SOLDER FROM A CIRCUIT
SUBSTRATE

Date of deposit: March 20, 2006

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Sir:

In response to the Office Action marked final and dated January 18, 2006, please enter the following remarks in the above-identified application as follows:

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.